

## PATENT ASSIGNMENT COVER SHEET

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| <b>SUBMISSION TYPE:</b>   | NEW ASSIGNMENT                       |
| <b>NATURE OF CONVEYANCE:</b>  | ASSIGNMENT                           |
| <b>CONVEYING PARTY DATA</b>   |                                      |
| <b>Name</b>   | <b>Execution Date</b>                |
| FRIEDBALD KIEL  | 07/26/2019                           |
| OLIVIER BELNOUE   | 07/31/2019                           |
| <b>RECEIVING PARTY DATA</b>   |                                      |
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| <b>Street Address:</b>  | 77 RUE DES CHANTIERS                 |
| <b>City:</b>  | VERSAILLES                           |
| <b>State/Country:</b>   | FRANCE                               |
| <b>Postal Code:</b>   | 78000                                |
| <b>Name:</b>  | ELVIA PCB                            |
| <b>Street Address:</b>  | AVENUE D'OCHSENFURT                  |
| <b>City:</b>  | COUTANCES CEDEX                      |
| <b>State/Country:</b>   | FRANCE                               |
| <b>Postal Code:</b>   | 50211                                |
| <b>PROPERTY NUMBERS Total: 1</b>  |                                      |
| <b>Property Type</b>  | <b>Number</b>                        |
| Application Number:   | 16470501                             |
| <b>CORRESPONDENCE DATA</b>  |                                      |
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| <b>ATTORNEY DOCKET NUMBER:</b>  | PEUG F485W1 / 17252-00070            |
| <b>NAME OF SUBMITTER:</b>   | JONATHAN P. SOIFER                   |
| <b>SIGNATURE:</b>   | /jonathan p soifer/                  |

|   |            |
|---|------------|
| <b>DATE SIGNED:</b>   | 09/23/2019 |
| <b>Total Attachments: 2</b><br>source=PEUG F485W1 - EXECUTED ASSIGNMENT - 2 PAGES#page1.tif<br>source=PEUG F485W1 - EXECUTED ASSIGNMENT - 2 PAGES#page2.tif |            |

## ASSIGNMENT

WHEREAS, We,

**FRIEDBALD KIEL**, a citizen of France, resident of the city of Fontainebleau, whose post office address is 2 bis boulevard du Maréchal Foch, 77300 Fontainebleau, France,

**OLIVIER BELNOUE**, a citizen of France, resident of the city of Ondreville-Sur-Essonne, whose post office address is 12 rue du marais de chatillon, 78730 Ondreville-Sur-Essonne, France,

(hereinafter, "ASSIGNOR(S)") have invented certain improvements in **ELECTRONIC POWER CIRCUITS COMPRISING BUS-BARS FORMING HEAT SINKS AND INTEGRATION METHOD** which International Application Number PCT/FR2017/053407 was filed on 6 December 2017 (which was published as WO 2018/115624) and for which French App. No. 1662803 was filed on 19 December 2016 and for which US App. No. 16/470501 was filed on 17 June 2019 (hereinafter, "IMPROVEMENTS").

AND, WHEREAS, **INSTITUT VEDECOM**, a French corporation, with offices at 77 rue des Chantiers, 78000 Versailles, France and **ELVIA PCB**, a French Corporation with offices at avenue d'Ochsenfurt, 50211 Coutances Cedex, France (hereinafter, "ASSIGNEES") are desirous of acquiring the entire right, title and interest in and to said improvements in said **ELECTRONIC POWER CIRCUITS COMPRISING BUS-BARS FORMING HEAT SINKS AND INTEGRATION METHOD** and all patent rights therefor;

NOW, THEREFORE, in consideration of good and valuable consideration, the receipt of which is hereby acknowledged, said ASSIGNOR(S) sell, assign, and transfer all their rights in improvements to said ASSIGNEE as follows:

We, said assignors, do hereby sell, assign, transfer and set over unto said ASSIGNEES, my entire right, title and interest in and to said IMPROVEMENTS, and in and to all Letters Patent and patent rights which may be granted or issued for said IMPROVEMENTS, in the United States and all other countries, and any reissue, reexamination, continuation, continuation-in-part, division, or extension thereof and any applications which claim priority thereto, the same to be held and enjoyed by said ASSIGNEES, their successors and assigns, as fully and entirely as the same would have been held and enjoyed by us if this Assignment and sale had not been made; and we agree to execute such further applications, declarations, powers of attorney, assignments and other documents as may be necessary or desirable to effectuate this Agreement: and

AND SAID ASSIGNORS DO HEREBY authorize and request the Commissioner of Patents and Trademarks to issue that said Letters Patent, when granted, to the said ASSIGNEE, its successors and assigns, as ASSIGNEE of the entire right, title and interest in and to said improvements, for the sole use and behoof of said ASSIGNEE, and

for their successors and assigns, to the full ends of the terms for which Letters Patent may be granted.

Date: 26/07/19

  
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FRIEDBALD KIEL, Inventor

Date: 31/07/19

  
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OLIVIER BELNOUE, Inventor